Press contacts:

Oleg Gorbachov
Corporate Communications Director,
RSC Group
+7 (967) 052-50-85
Email: oleg.gorbachov@rscgroup.ru

Press Release

RSC introduces universal hyper-converged “hot water” cooled HPC solution based on 2nd Generation Intel® Xeon® Scalable processors featuring Intel® Optane™ DC persistent memory

Moscow, April 2, 2019 — RSC Group, the leading developer and integrator of ultrahigh-density, scalable and energy efficient solutions for HPC and data centers, introduced the next generation of its RSC Tornado universal hyper-converged “hot water” liquid-cooled HPC solutions based on the newest 2nd Generation Intel® Xeon® Scalable processors featuring Intel® Optane™ DC persistent memory. It provides more computational performance as well as is ready to run with typical usage scenarios in hyper-converged environment for high-speed distributed data storage systems based on Intel® Optane™ SSDs and regular Intel® SSDs. Also, RSC will upgrade its Intel® Select Solution for Simulation and Modeling as well as Intel® Select Solution for Professional Visualization on the 2nd Generation Intel® Xeon® Scalable processors by May 2019.

Universal, hyper-converged and ultrahigh-density RSC Tornado solutions are based on a full package of components for modern cluster systems of different scale. These solutions feature 100% “hot water” liquid cooling and include nodes based on high-end 2nd Generation Intel® Xeon® Platinum processors or 2nd Generation Intel® Xeon® Gold processors, Intel® Server Board S2600BP and high-speed Intel® SSDs with NVMe in high density M.2 format, including the latest Intel® Optane™ SSD DC P4801X. RSC Tornado solutions feature Intel® Omni-Path Edge Switch 100 Series with 100% liquid cooling providing high efficiency of “hot water” cooling system and the lowest TCO.

“We’re glad to introduce today the upgraded RSC Tornado universal and hyper-converged “hot water” liquid-cooled HPC solutions based on the 2nd Generation Intel® Xeon® Scalable processors and to be part of the worldwide launch” – said Alexey Shmelev, COO of RSC Group.

“We believe that end customers will get more performance advantages in running their applied tasks and doing a deep science research while using the newest 2nd Generation Intel® Xeon® Scalable processors featuring Intel® Optane™ DC persistent memory both supported by the next generation of RSC Tornado universal HPC solutions” – said Jim Jeffers, Senior Principal Engineer & Senior Director, Advanced Rendering and Visualization for Intel’s Data Center Group.
RSC Tornado solutions based on Intel® processors has leading footprint and computing density (up to 153 nodes in one standard 42U cabinet), high energy efficiency and provides stable operation of computing nodes in “hot water” mode with cooling agent temperature up to +65 °C at inlets of switching nodes and interconnects. Operation in “hot water” mode enables all-year free cooling (24x365) using only dry coolers running at ambient air temperature up to +50 °C, and complete elimination of chillers. As the result, average power efficiency factor (PUE) is less than 1.06, which is an outstanding score for HPC industry.

The hyper-converged node of RSC Tornado solution enables storage-on-demand providing record-breaking performance of 1.1 TB/s per rack with over 495 million IOPS (input/output operations per second). This solution provides flexible storage configurations based on Intel® Optane™ SSDs and regular Intel® SSDs. Hyper-converged RSC Tornado solution enables “on-the-fly” definition of storage system architecture after equipment installation adapting the system to various user-dependent workloads. RSC BasIS software stack configures communication topologies and other storage parameters and runs continuous orchestration (automatic allocation, coordination and management of complex computer systems and services) essentially creating a software-defined solution in a hyper-converged environment.

RSC Tornado server node with direct liquid cooling working in “hot water” mode is well balanced for various computing tasks and may be a part of on-demand storage systems based on different file systems, such as Lustre (Lustre-on-demand). RSC Tornado node may contain up to 12 solid-state drives (Intel® Optane™ SSD DC P4801X M.2 Series or Intel® SSD DC P4511 NVMe M.2), 2nd Generation Intel® Xeon® Scalable processor and Intel® Server Board S2600BP. It allows to create up to 24 TB of high-performance low-latency storage with just one node, and with SSD density improvements storage volumes will keep growing. Hyper-converged RSC Tornado architecture supports different types of SSD-based high-performance on-demand storage systems, including Lustre-based partitions and easily integrates with various HPC workload schedulers.

RSC specialists have solid experience in the creation and deployment of computing clusters with integrated storage systems based on Intel's solid-state drives. For example, a supercomputer based on hyper-converged RSC Tornado solution with Intel SSD-based storage system has been deployed in the Joint Institute of Nuclear Research (Dubna, Russia) in 2018. This system has been ranked on 9th position among HPC class storage systems in the global IO500 rating (June 2018).

The innovative management and monitoring system based on RSC BasIS integrated software stack also provides high availability, resistance to failures and ease of use of computing systems based on RSC solutions. This system is an open and easily expandable platform based on open source software and micro-agent architecture.

It enables full control of data centers and their components, such as computing nodes, interconnects, infrastructure components, workloads and processes. All elements of the system (computing nodes, power supplies, hydraulic regulation modules, etc.) have an integrated management module providing broad capabilities for detailed telemetry and flexible management. The cabinet design supports replacement of computing nodes, power supplies and hydraulic regulation modules (with redundancy) in hot-swap mode without interruption of system operation. Most components of the system (such as computing nodes, power supplies, network and infrastructure components, etc.) are software-defined, and this significantly simplifies and speeds up initial deployment, maintenance and future upgrades of the system. Liquid cooling of all components ensures their longevity.
RSC BasIS has features for monitoring and control of geographically distributed data centers.

About RSC Group
RSC Group is the leading Russian developer and integrator of innovative ultrahigh-density HPC and data center solutions based on Intel architecture, the latest liquid cooling technologies and its own extensive know-how. Since 2018, RSC is a member of “National Champions” priority project of the Ministry of Economic Development of the Russian Federation.
RSC has the potential to create the most energy efficient solutions with record-breaking power usage effectiveness (PUE), the highest computing density in the industry with standard x86-based processors, to use fully “green” design, provide the highest solution reliability, noise-free operation of computing modules, 100% compatibility and guaranteed scalability with unmatched low cost of ownership and low power consumption. RSC specialists also have the experience of developing and implementing an integrated software stack of solutions to improve work efficiency and application of supercomputer systems from system software to vertically oriented platforms based on cloud computing technologies.
RSC participates in Intel® Technology Provider Program at Platinum level, Intel® Select Solution for Simulation and Modeling, Intel® Select Solution for Professional Visualization, Intel® HPC and Data Center Specialist, Intel® Fabric Builders, Intel® Solutions for Lustre Reseller Elite programs. Performance and scalability of RSC Tornado solutions are certified as Intel® Cluster Ready. For more information please visit www.rscgroup.ru.
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